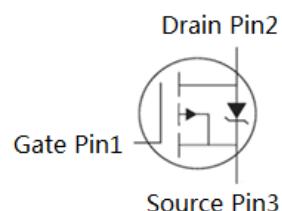
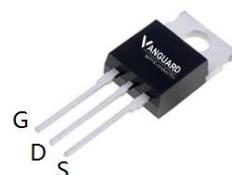


Features

- P-Channel, -5V Logic Level Control
- Enhancement mode
- Low on-resistance RDS(on) @ $V_{GS}=-4.5\text{ V}$
- Fast Switching and High efficiency
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant

V_{DS}	-30	V
$R_{DS(on),TYP}$ @ $V_{GS}=-10\text{ V}$	6.2	$\text{m}\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=-4.5\text{ V}$	10	$\text{m}\Omega$
I_D	-100	A

TO-220AB


Part ID	Package Type	Marking	Tape and reel information
VS3506AT	TO-220AB	3506AT	50pcs/Tube

Maximum ratings, at $T_A = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit	
$V_{(BR)DSS}$	Drain-Source breakdown voltage	-30	V	
V_{GS}	Gate-Source voltage	± 20	V	
I_S	Diode continuous forward current	$T_c=25^\circ\text{C}$	-100	A
I_D	Continuous drain current @ $V_{GS}=-10\text{V}$	$T_c=25^\circ\text{C}$	-100	A
		$T_c=100^\circ\text{C}$	-71	A
I_{DM}	Pulse drain current tested ①	$T_c=25^\circ\text{C}$	-400	A
I_{DSM}	Continuous drain current @ $V_{GS}=-10\text{V}$	$T_A=25^\circ\text{C}$	-15	A
		$T_A=70^\circ\text{C}$	-12	A
EAS	Avalanche energy, single pulsed ②	163	mJ	
P_D	Maximum power dissipation	$T_c=25^\circ\text{C}$	94	W
P_{DSM}	Maximum power dissipation ③	$T_A=25^\circ\text{C}$	2	W
T_{STG}, T_J	Storage and Junction Temperature Range	-55 to 175	$^\circ\text{C}$	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.6	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	$^\circ\text{C}/\text{W}$

Typical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	-1	μA
	Zero Gate Voltage Drain Current($T_J=125^\circ\text{C}$)	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1.2	--	-2.3	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-30\text{A}$	--	6.2	8.7	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-20\text{A}$	--	10	14	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	3765	4430	5090	pF
C_{oss}	Output Capacitance		445	525	600	pF
C_{rss}	Reverse Transfer Capacitance		365	430	490	pF
R_g	Gate Resistance	$f=1\text{MHz}$	--	4.6	--	Ω
$Q_g(10\text{V})$	Total Gate Charge	$V_{\text{DS}}=-15\text{V}, I_{\text{D}}=-30\text{A}, V_{\text{GS}}=-10\text{V}$	--	73	--	nC
$Q_g(4.5\text{V})$	Total Gate Charge		--	41	--	nC
Q_{gs}	Gate-Source Charge		--	12	--	nC
Q_{gd}	Gate-Drain Charge		--	18	--	nC
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-15\text{V}, I_{\text{D}}=-30\text{A}, R_{\text{G}}=3.0\Omega, V_{\text{GS}}=-10\text{V}$	--	12	--	ns
t_r	Turn-on Rise Time		--	8.5	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	77.5	--	ns
t_f	Turn-Off Fall Time		--	19.5	--	ns
Source- Drain Diode Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise stated)						
V_{SD}	Forward on voltage	$I_{\text{SD}}=-30\text{A}, V_{\text{GS}}=0\text{V}$	--	-0.9	-1.2	V
t_{rr}	Reverse Recovery Time	$T_J=25^\circ\text{C}, I_{\text{SD}}=-30\text{A}, V_{\text{GS}}=0\text{V}, \frac{di}{dt}=-500\text{A}/\mu\text{s}$	--	31	--	ns
Q_{rr}	Reverse Recovery Charge		--	15.5	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Limited by $T_{J\text{max}}$, starting $T_J = 25^\circ\text{C}$, $L = 0.5\text{mH}$, $R_G = 25\Omega$, $I_{AS} = -20\text{A}$, $V_{GS} = -10\text{V}$. Part not recommended for use above this value
- ③ The power dissipation P_{DSM} is based on $R_{\theta\text{JA}}$ and the maximum allowed junction temperature of 150°C .
- ④ Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.



Vanguard
Semiconductor

VS3506AT

-30V/-100A P-Channel Advanced Power MOSFET

Typical Characteristics

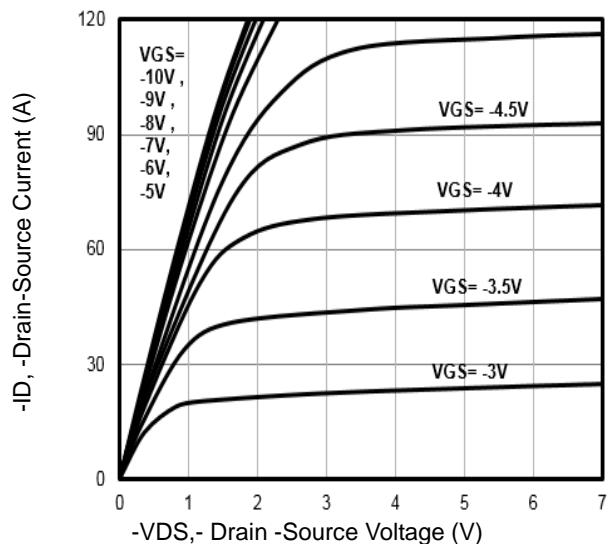


Fig1. Typical Output Characteristics

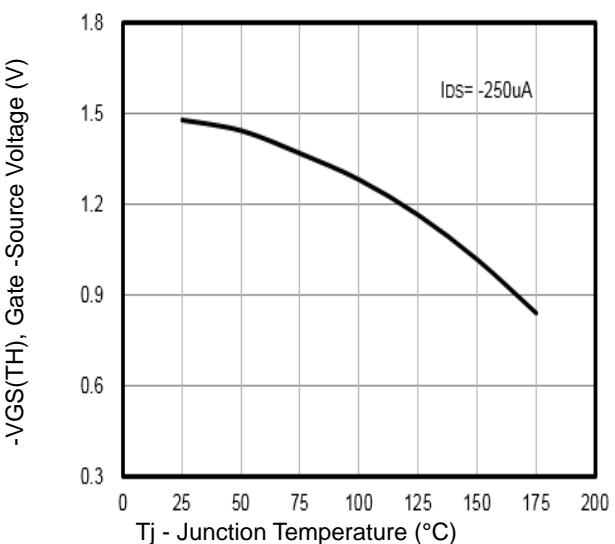


Fig2. $-VGS(TH)$ Gate -Source Voltage Vs. T_j

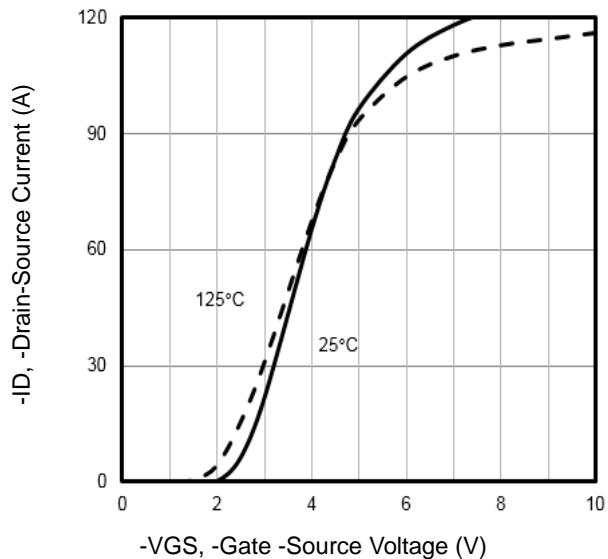


Fig3. Typical Transfer Characteristics

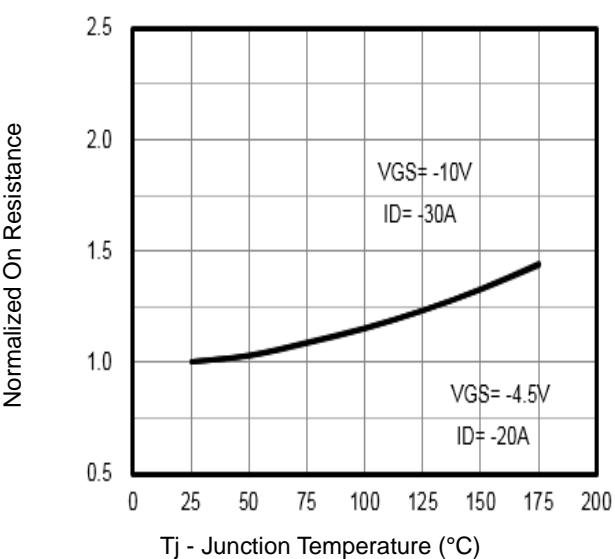


Fig4. Normalized On-Resistance Vs. T_j

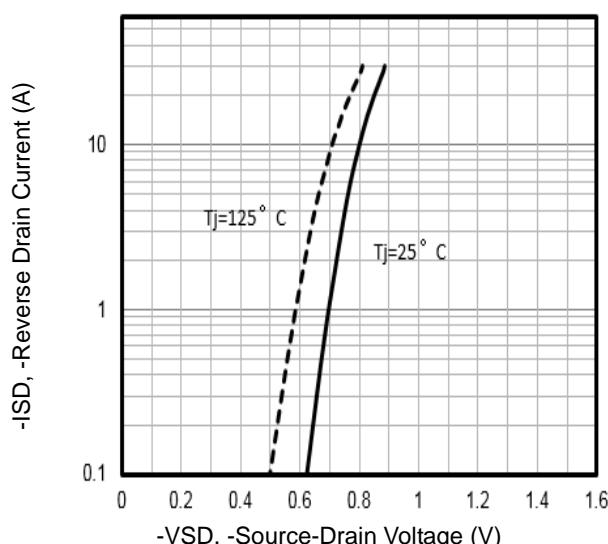


Fig5. Typical Source-Drain Diode Forward Voltage

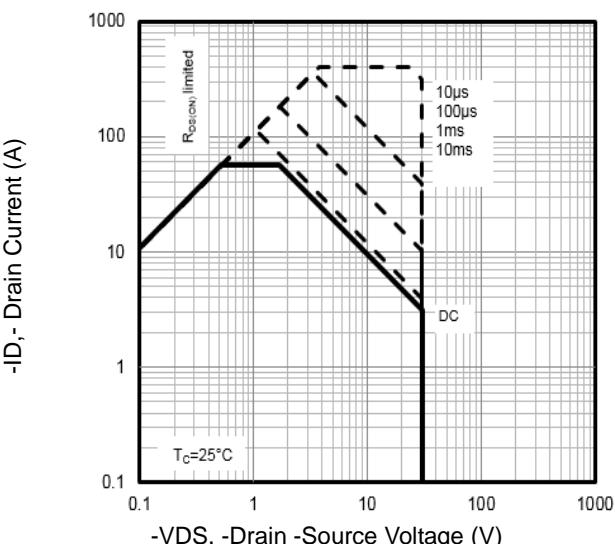


Fig6. Maximum Safe Operating Area



Vanguard
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VS3506AT

-30V/-100A P-Channel Advanced Power MOSFET

Typical Characteristics

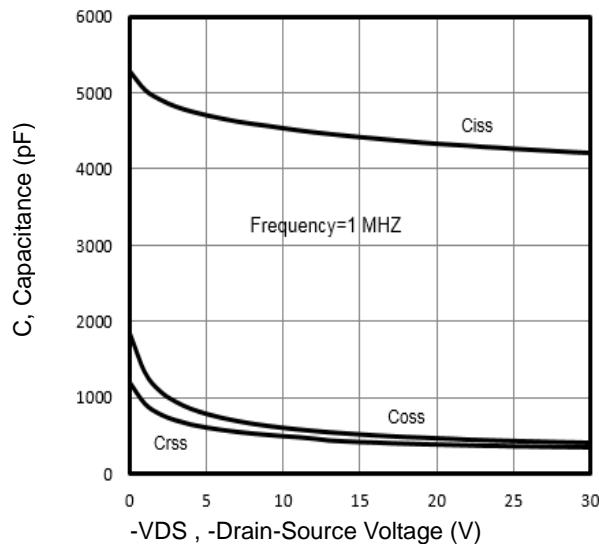


Fig7. Typical Capacitance Vs.Drain-Source Voltage

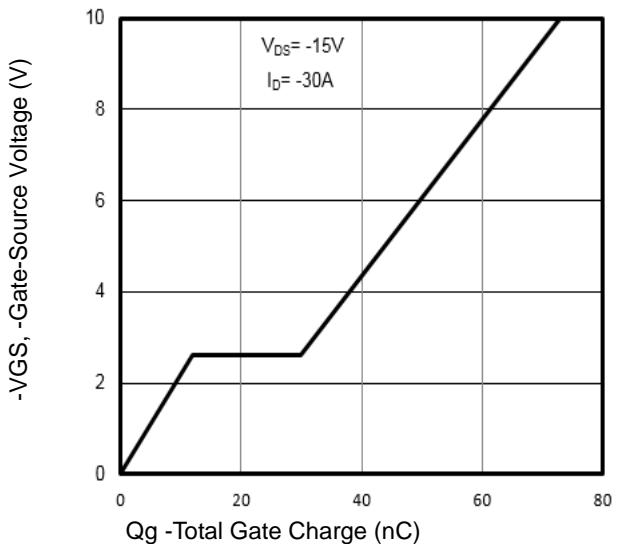


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

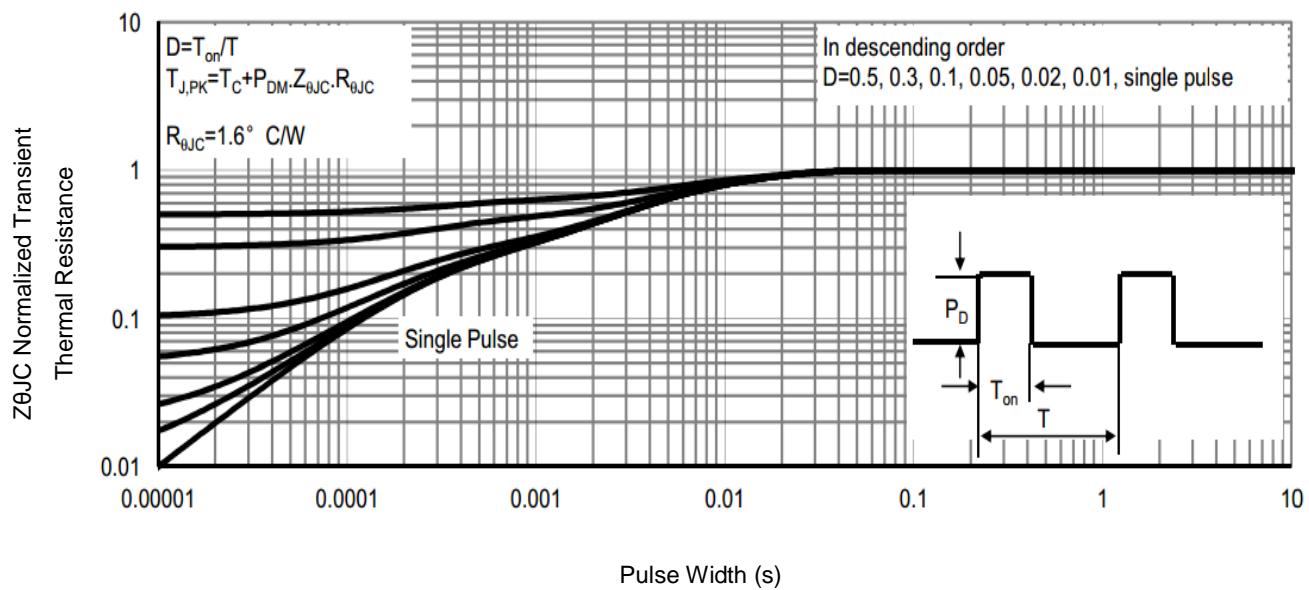


Fig9. Normalized Maximum Transient Thermal Impedance

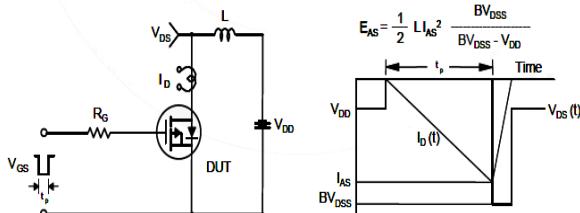


Fig10. Unclamped Inductive Test Circuit and Waveforms

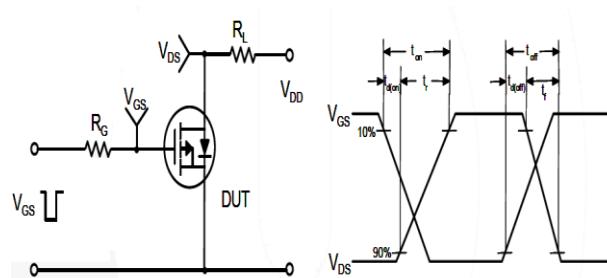
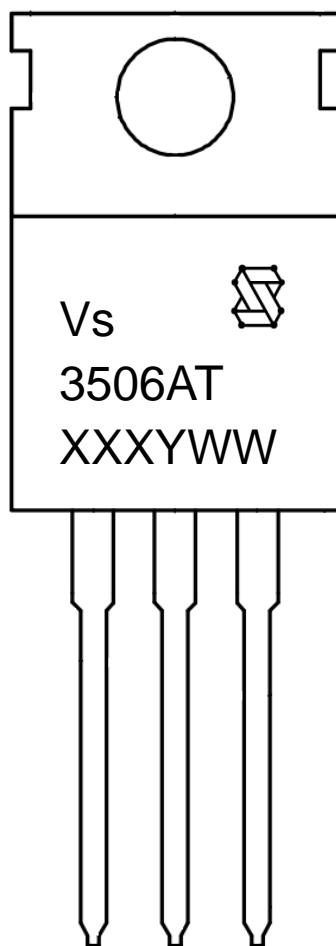


Fig11. Switching Time Test Circuit and waveforms

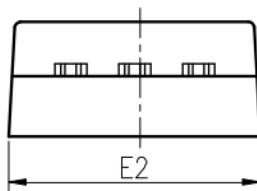
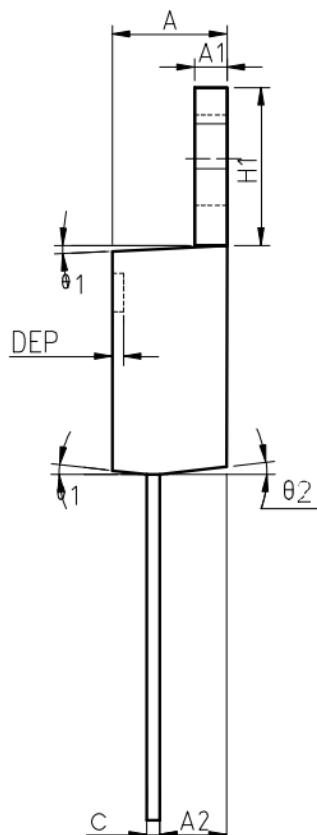
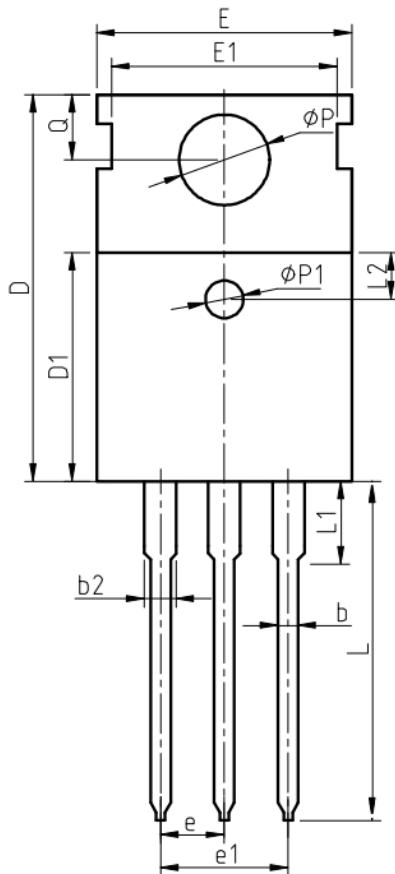
Marking Information



1st line: Vanguard Code (Vs), Vanguard Logo
2nd line: Part Number (3506AT)
3rd line: Date code (XXXYWW)
XXX: Wafer Lot Number
Y: Year Code, e.g. E means 2017
WW: Week Code



TO-220AB Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	4.30	4.52	4.70
A1	1.15	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	1.00
b2	1.17	1.32	1.50
c	0.45	0.50	0.61
D	15.30	15.65	15.90
D1	9.00	9.20	9.40
DEP	0.05	0.10	0.25
E	9.66	9.90	10.28
E1	-	8.70	-
E2	9.80	10.00	10.20
φP1	1.40	1.50	1.60
e	2.54 BSC		
e1	5.08 BSC		
H1	6.40	6.50	6.80
L	12.70	-	14.27
L1	-	-	3.95
L2	2.40	2.50	2.60
φP	3.53	3.60	3.70
Q	2.70	2.80	2.90
θ1	5 °	7 °	9 °
θ2	1 °	3 °	5 °

Notes:

1. Refer to JEDEC TO-220 variation AB
2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.

Customer Service

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